Novel very low Energy Electron Sources – an Overview

Customized Accelerators The Basis of a successful Application Development

EuCARD-2 Workshop with Industry 8-9 December 2016 Warsaw, Poland

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Head of Department
Electron Beam Processes









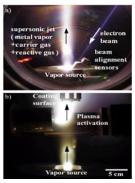




Outline

- Electron Beam Basics
- Customized eBeam-Sources
- Summary







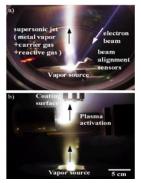




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- Summary





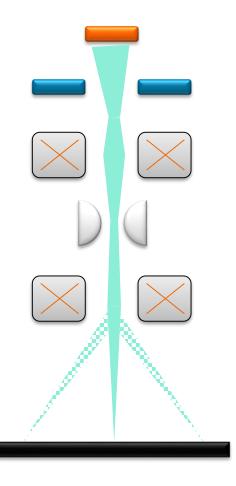






Electron Beam Technology - Basics

Principles of electron beam generation and processing



Cathode, emits electrons

Acceleration anode

Electromagnetic beam shaping, centering and stigmatic correction

Pressure decoupling between electron generation and processing

Electromagnetic beam focussing and fast deflection

Workpiece





Electron Beam Technology - Basics

Effect of Electron Beam Interaction

Thermal Processes

Non-thermal Processes

Heat Production

Chemical Reactions

Biocidal Effects

Vacuum

Atmosphere

Atmosphere

- Evaporation
- Melting
- Welding / Joining
- Hardening
- Micro- structuring

- Curing
- Crosslinking
- Drying print-inks
- Surface modification (Grafting)

- Disinfection
- Seed treatment
- Sterilisation
- Inactivation
- Cell-modification

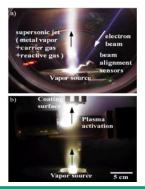




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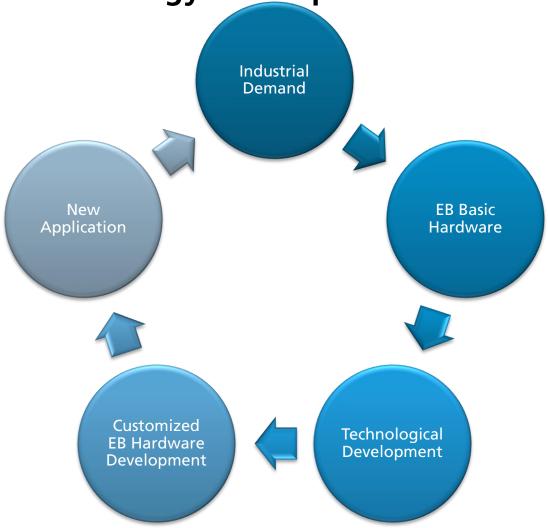






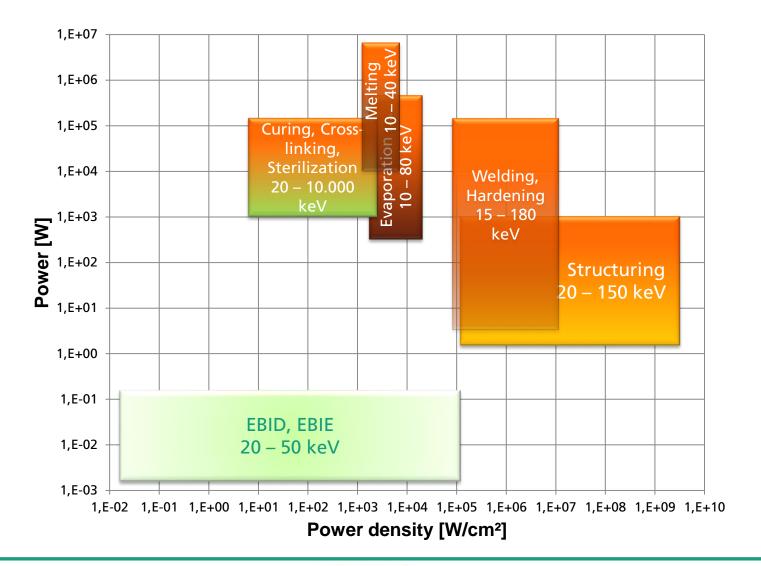


Customized eBeam-Sources The circle of technology development



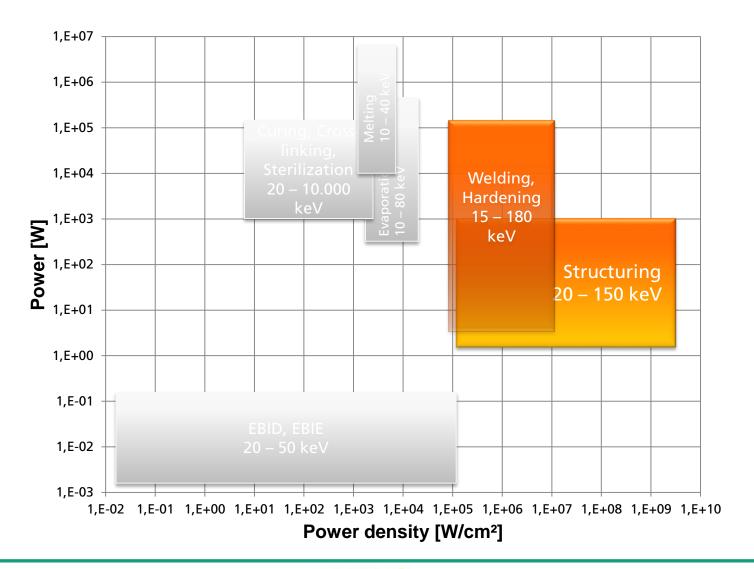


Electron Beam Technology - Applications





Applications – Welding, Structuring



EUCARD²

Customized eBeam-Sources

Thermionic Emitter

Cold Cathode Emitter

Axial gun CTW 80 W – 10 kW

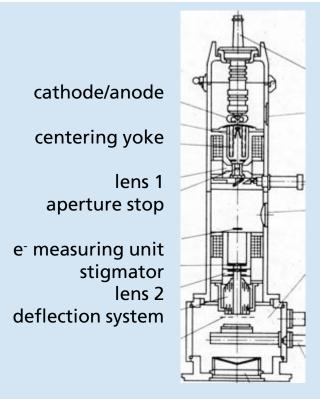
40 – 70 kV



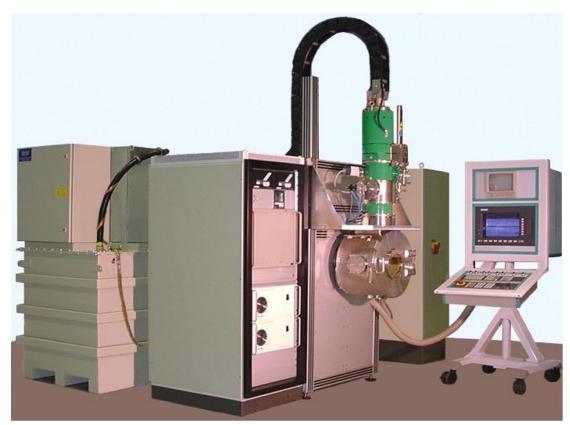
Low power axial gun – Basic ST 10/60

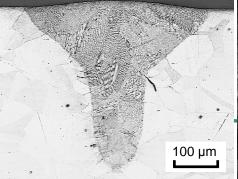
- acceleration voltage40 ... 60 kV
- maximum beam power80 W ... 10 kW
- beam diameter 15 ... 500 µm
- deflection field30 x 20 ... 100 x 100 mm²
- deflection frequency200 kHz

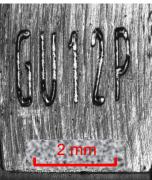














Operation characteristic:

⇒ production plant

Technologies:

- ⇒ EB microwelding of mini sensors welding depth ≈ 750 μm, seam width ≈ 100 μm
- ⇒ EB microlabeling Structural width: ≥ 50 μm

Components:

- ⇒ EB gun ST 2 kW / 70 kV
- ⇒ HSS beam deflection unit
- ⇒ surface imaging and automatic beam alignment by backscattered electrons (RICO system)
- ⇒ Technology Package

Customized eBeam-Sources

Thermionic Emitter

Axial gun MEBW 2 kW

60 kV

Axial gun CTW 80 W – 10 kW

10 - 70 kV

Cold Cathode Emitter



Low power axial gun – Basic MEBW 60

- Supplier: Focus GmbH
- basic research in the field of electron beam micro-welding, engraving, structuring
- development of technologies for customer parts
- investigations regarding new applications of electron beam technology
- electron beam gun 2 kW / 60kV
- wide angel deflection ± 35°
- work pressure 5 x 10⁻⁴ mbar
- substrate size $150 \times 150 \times 150 \text{ mm}$
- 1 rotatable axis
 0 ... 32 min⁻¹
- short cycle times < 2 min</p>

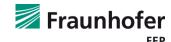












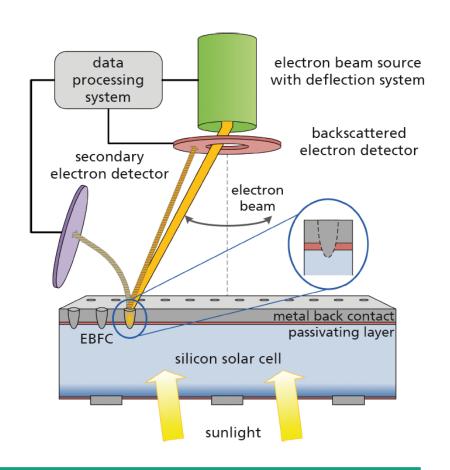
EBFC: Customized eBeam-Source

MEBW 60 - EmicPro

Surface Passivation and Electron Beam - fired Contacts (EBFC)

For this task, the electron beam has some advantages over the laser:

- Energetic electrons can penetrate thick metal layers with volumetric, adjustable absorption profile and with low energy reflection losses.
- High-power electron beam can economically be generated and operated in cw or pulsed mode
- Inertia-less beam deflection enables very fast processing (goal: 7.200 8"-wafers / hour).
- EB-contact formation is a vacuum-based process.
 Therefore, it is per se compatible to vacuum deposition modules in a solar cell production line.
- Secondary effects (BSE, SE, X-ray, current probe...) can be used for process monitoring / quality control.









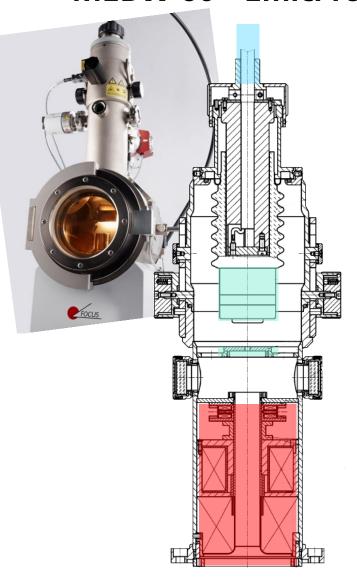


EBFC: Customized eBeam-Source

MEBW 60 - EmicPro

Development of next generation

- Pulsed high-voltage supply for fast modulation of beam power
- Optimized new developed cathode and anode for better beam quality and longer cathodelifetime
- ➤ Development of electron-optics for micro-machining of large areas (deflection system, dynamic lenses, alignment, stigmator)
- Synchronization of all "beamaxes" together with handling axes



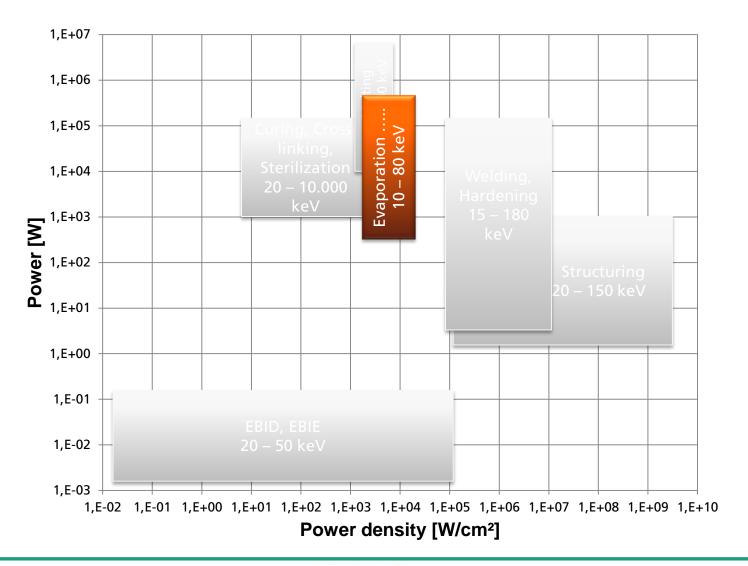








Applications – Evaporation





Customized eBeam-Sources

Thermionic Emitter

Axial gun MEBW 2 kW

60 kV

Axial gun CTW 80 W – 10 kW

10 - 70 kV

Axial gun ERIC 60 – 300 kW

40 - 80 kV

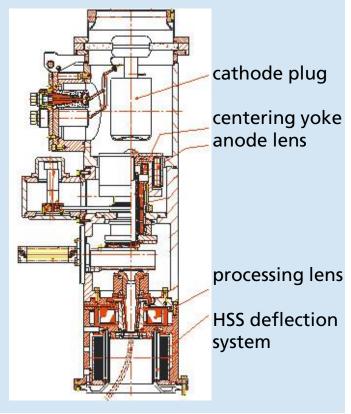
Cold Cathode Emitter



High power axial gun – Basic ERIC 160/40

- acceleration voltage 40 kV
- maximum beam power 160 kW
- beam diameter app. 10 mm
- deflection angle 30°
- deflection frequency3.5 kHz



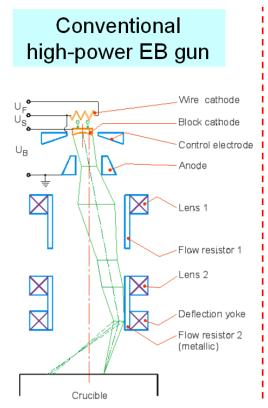


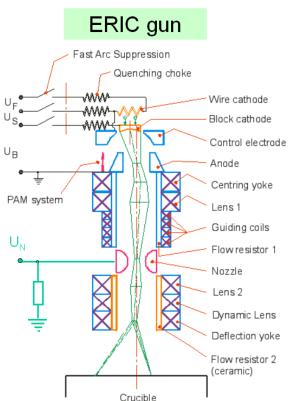




ERIC eBeam System

EB system for **R**eactive **I**on-aided **C**oating of large-area substrates at high rates



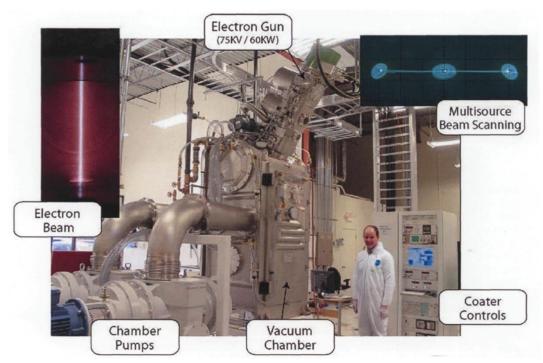


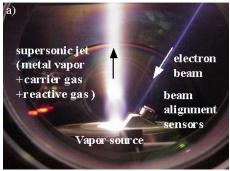
Development Goals:

- Coating Chamber Pressure ≤ 5 Pa
- Arc recovery time < 5 ms
- Acceleration voltage ≤ 60 kV
- Beam Power ≤ 300 kW
- Power Control
 - in space charge limited mode
 - in thermal saturation mode
- Automatic Centering / Focusing
- Scan frequency x/y ≤ 10 kHz @ 45°
- Dynamic Focusing ≤ 10 kHz @ 10%
- Extended cathode service life



DVD-Process: Customized eBeam-Source ERIC-LVO 60/75







Customer's Technology:

- ⇒ Directed Vapor Deposition (R&D / Pilot Scale)
- ⇒ Application examples:
 - Thermal barrier & bond coatings
 - Hot corrosion resistant coatings

FEP Components:

- ⇒ EB gun ERIC-LVO 60 kW / 75 kV
 - operation pressure ≤ 30 Pa
 - deflection angle ± 30 °
 - deflection frequency ≤ 3 kHz
 - arc recovery time ≈ 5 ms
 - MF high-voltage power supply
 - three-stage vacuum system
- ⇒ Control system & Supply cabinet





Customized eBeam-Sources

Thermionic Emitter

Axial gun MEBW 2 kW

60 kV

Axial gun CTW 80 W – 10 kW

10 – 70 kV

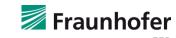
Axial gun ERIC 60 – 300 kW

40 - 80 kV

Cold Cathode Emitter

20 - 45 kV

Axial gun EasyBeam 30 - 400 kW

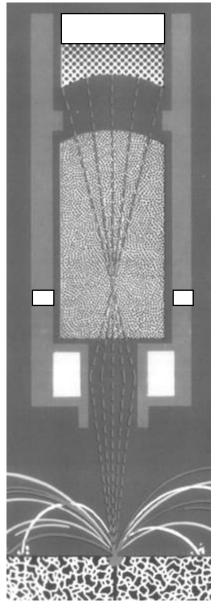


Cold-Cathode EB Guns

Cold-Cathode Glow-Discharge Electron Beam sources for PVD -

Some Work Principles

- Inside the beam source, a high-voltage glowdischarge is sustained. The potential drop between cathode and anode occurs mainly across the cathode sheath. (U = 10...40 kV)
- Bombardment of the cathode by ions from the plasma generates secondary electrons (Emission current density up to 100 mA/cm²)
- Secondary electrons are accelerated through the cathode sheath ("transparent anode") appropriate cathode contour promotes shaping of an Electron Beam with cross-over
- Then: Conventional electron optics applicable



Insulator

Cathode

Cathode Sheath

Anode Plasma

Case = Anode

Gas Inlet

Anode Aperture

Lens & Deflection

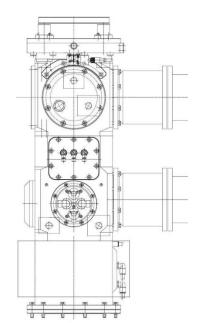
Electron Beam

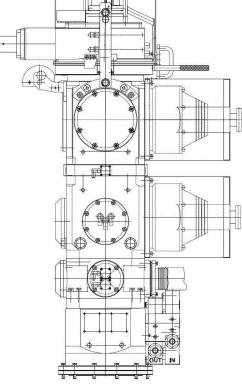
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Fraunhofer FEP: High-Power Gun Series









Туре	EasyBeam	ERIC	ERIC-LVO
Acceleration Voltage	30 40 kV	40 60 kV	75 80 kV
Beam Power	30 150 kW	60 300 kW	60 300 kW
Coating Chamber Pressure Flange Size	≤ 1.0 Pa	≤ 5.0 Pa	≤ 50 Pa
	NW 100 160	NW 250	NW 250
Turbo Pumps	No	2	2
Roots Blower	No	No	1
Gun mounting angle	0° 135°	0° 135°	0° 135°
Beam Scan angle / frequency	± 30° / 1 kHz	± 35° / 1 10 kHz	± 35° / 1 10 kHz





High-rate PVD:

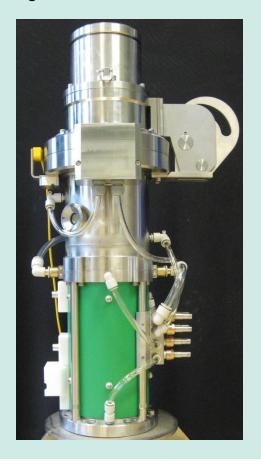
Customized eBeam-Source EasyBeam 120/40

"EasyBeam" 60 kW / 30 kV

Beam Scanning: ±15°, f <100 Hz

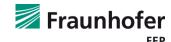


"EasyBeam" 120 kW / 40 kV Beam Scanning: ± 30°, f < 1 kHz









Melt-refining + High-rate PVD: Customized eBeam-Source EasyBeam-Hybrid

The next generation - HYBRID CATHODE approach

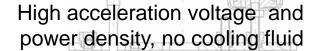
"Merge the best of both worlds!"

Simplified design and supply, easy to control and to adjust

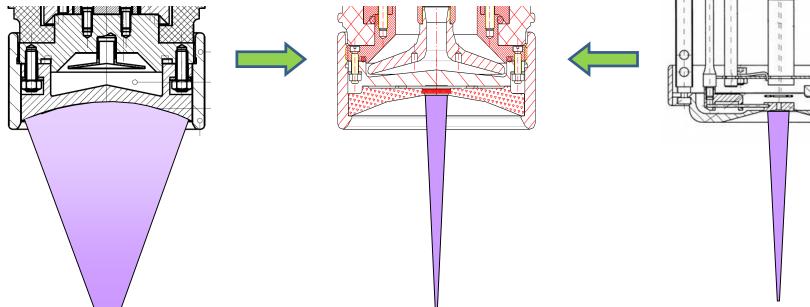
cold cathode plug with aluminum cathode

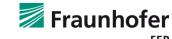
LaB₆ emitter in graphite holder

hybrid cathode plug with



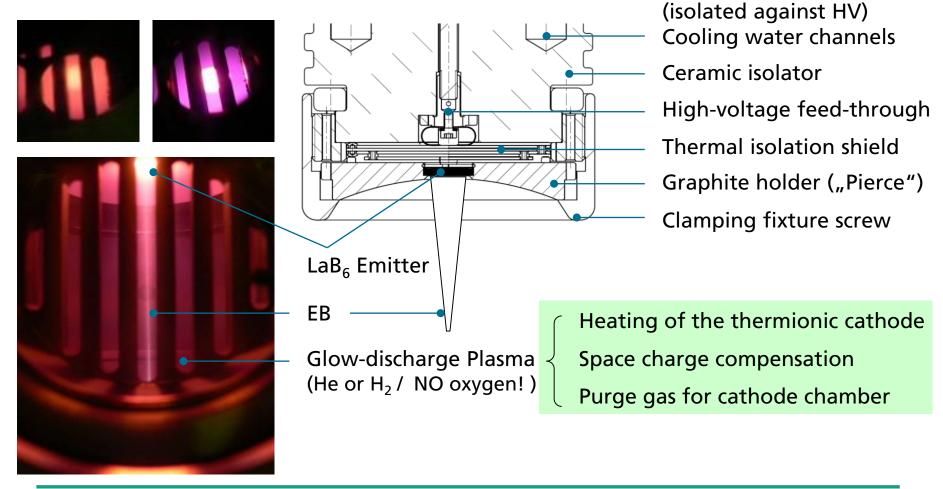
cathode plug with thermionic tungsten emitter





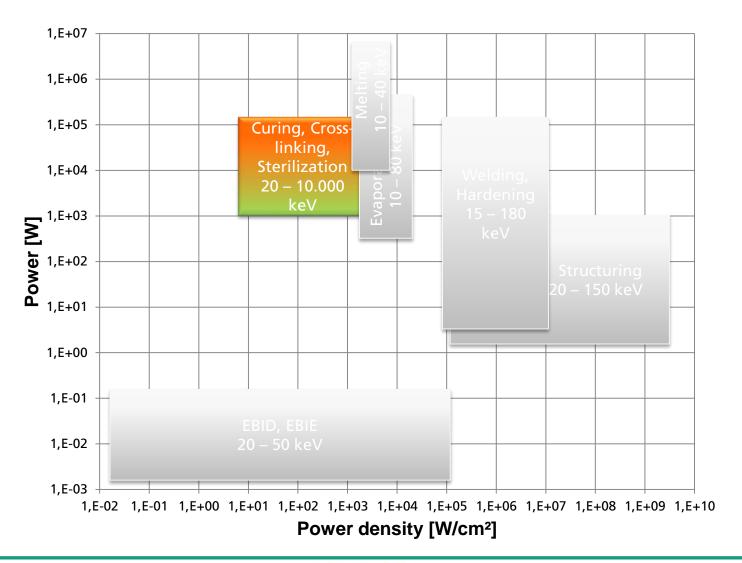
High-Voltage Glow-Discharge EB sources with

Hybrid Cathodes





Applications – Curing, Crosslinking, Sterilization









Customized eBeam-Sources

Thermionic Emitter

Axial gun MEBW 2 kW

60 kV

Axial gun CTW 80 W – 10 kW

10 - 70 kV

Axial gun ERIC 60 – 300 kW

40 - 80 kV

Broadbeam FEPtron 30 kW

150 kV

Cold Cathode Emitter

20 kV

PED gun
1 J per pulse

20 - 45 kV

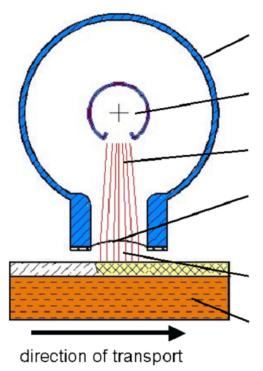
Axial gun EasyBeam 30 - 400 kW

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High power linear gun – Basic FEPtron 5/120



Linear type EB gun, high-vacuum inside

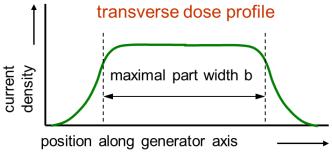
Cathode system

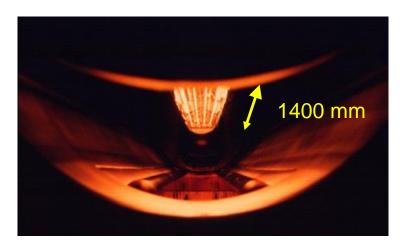
Electrons with energy $E_{kin} = e \cdot U_{B}$

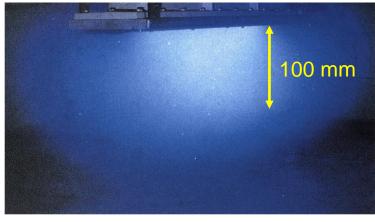
Electron exit window: A metal membrane between atmosphere and high vacuum

Electron curtain directed onto product

Product with treated border layer and untreated coating





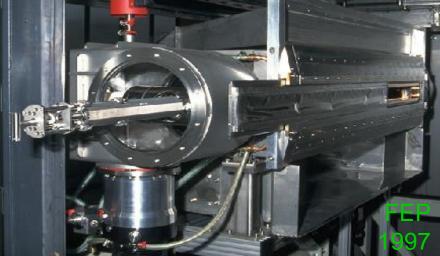






Seed Treatment: Customized eBeam-Source FEPtron 30/150





Pilot Plant WESENITZ 2

- troughput 30 t/h
- chemical free seed treatment

FEP's Low-Energy Technology allows to adapt acceleration voltage

- ⇒ improved dose homogeneity across layer
- ⇒ reduced loads of the carrier material
- ⇒ optimized investment costs

2D EB Systems available at FEP

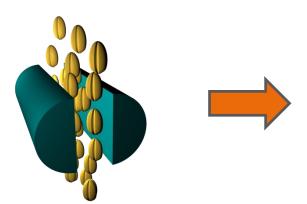
2D EB System type	Lab	Production I
Acceleration voltage (kV)	80 - 120	80 – 150
Layer thickness (µm)	10 - 60	10 – 120
Dynamic dose rate (kGy·m/min)	4 000	4 000 - 6 000
Transportation speed (m/min)	1 - 600	f (D)
Homogeneity of dose (%)	< ±15	< ±10
Working width (mm)	300	1 400





Electron treatment of surfaces

Treatment of seed or bulk goods

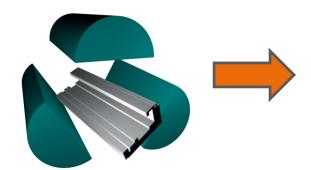


Surface sterilization of medical products



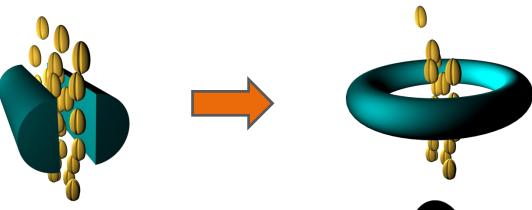
It would be nice
to have a
toroidal source
for
homogenious
dose application
onto 3D-surfaces

Lacquer curing on 3D-products



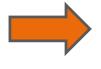
Electron treatment of surfaces

Treatment of seed or bulk goods



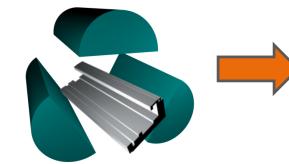
Surface sterilization of medical products

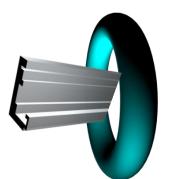






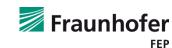
Lacquer curing on 3D-products











Customized eBeam-Sources

Thermionic Emitter

Axial gun MEBW 2 kW

60 kV

Axial gun CTW 80 W – 10 kW

10 - 70 kV

Axial gun ERIC 60 – 300 kW

40 – 80 kV

Axial gun Scanner 2 kW

150 kV

Broadbeam FEPtron 30 kW

150 kV

Cold Cathode Emitter

20 kV

PED gun
1 J per pulse

20 - 45 kV

Axial gun EasyBeam 30 - 400 kW

150 kV

Toroidal gun TORES 5 - ? kW

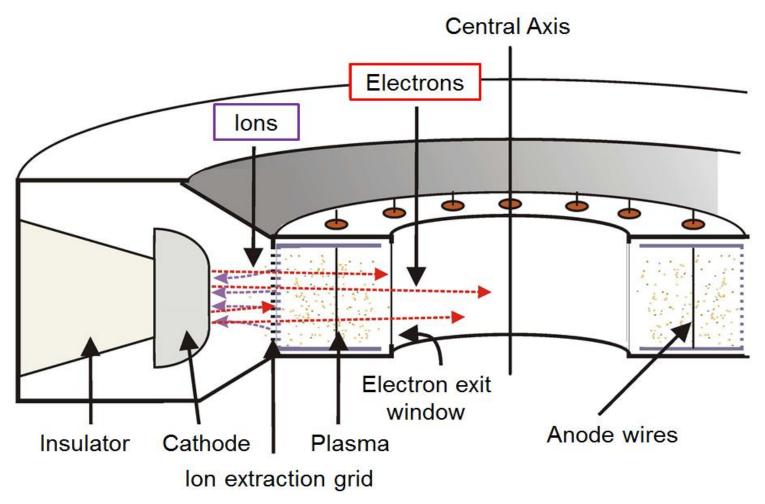






High power toroidal gun – Basic

TORES 5/120

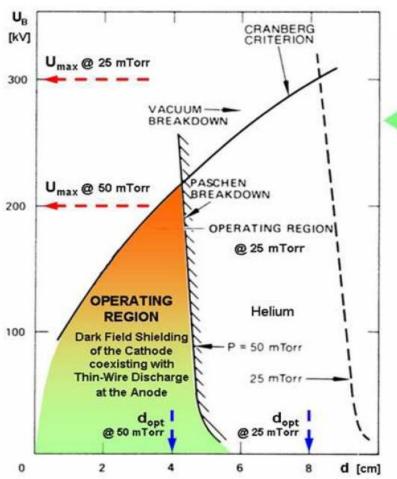






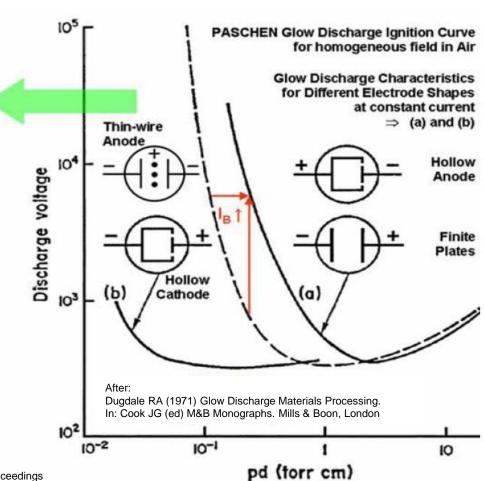
High-Voltage Glow-Discharge EB sources with Plasma Anode -

Issues: Dark-field Shielding



Solution:

Create an auxiliary low-pressure plasma for ion production (Hollow Cathode or Wire Anode)



After: Amboss K (1974) Design of large area electron beam guns. In: Bakish R (ed) Proceedings of the 6th International conference on electron and ion beam science and technology, pp 497-517

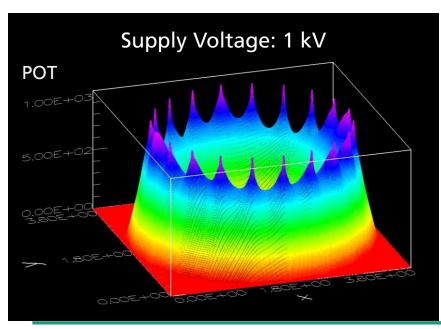


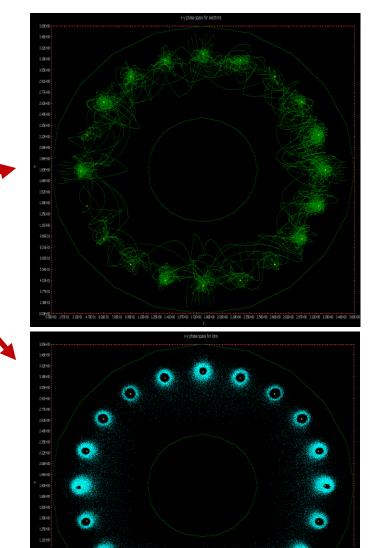


Toroidal EB source with Wire Anode Discharge Plasma

Numerical Simulation – Overview of Results

- Electron trajectories ⇒ Trapping
- Ion density distribution ⇒ Localization
- Distribution of electric potential
 Repelling ions off the wires











Customized eBeam-Sources

Thermionic Emitter

Axial gun MEBW 2 kW

60 kV

Axial gun CTW 80 W – 10 kW

10 - 70 kV

Axial gun ERIC 60 – 300 kW

40 – 80 kV

Axial gun Scanner 2 kW

150 kV

Broadbeam FEPtron 30 kW

150 kV

X-Ray gun 10 kW

150 kV

Cold Cathode Emitter

20 kV

PED gun
1 J per pulse

20 - 45 kV

Axial gun EasyBeam 30 - 400 kW

150 kV

Toroidal gun TORES 5 - ? kW

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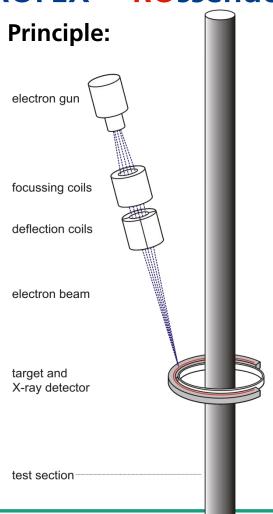


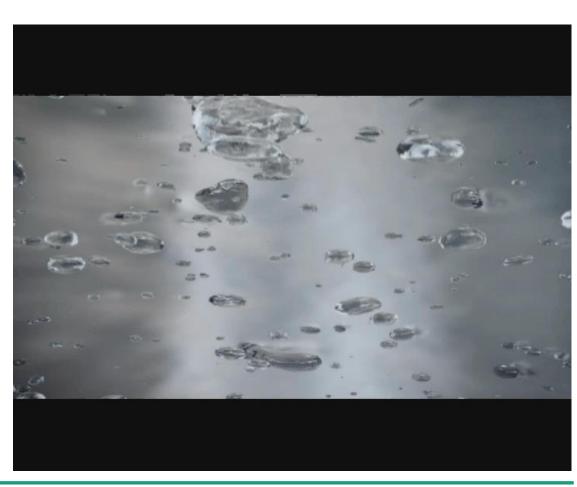


Fast 3D X-Ray:

Customized eBeam-Source ROFEX 10/150 (based on ROBOTGUN)

ROFEX – ROssendorf Fast Electron beam X-ray tomograph

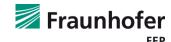












Ultra-fast X-ray computed tomography

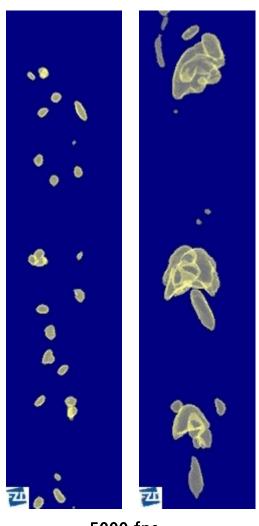
- Basics: Fast deflected electron beam sources with sub-mm spot by FEP
- New technical application for investigation of multiphase fluid flow
- Interesting in boiling processes at power plant heating tubes and multi-phase fluids at petrol industry
- Possibility to get moved CT-pictures for fast dynamic investigation
- Cooperation in the field of ultra-fast Xray detection with Institute of Safety Research, Helmholtz-Zentrum Dresden-Rossendorf



low gas flow rate



high gas flow rate

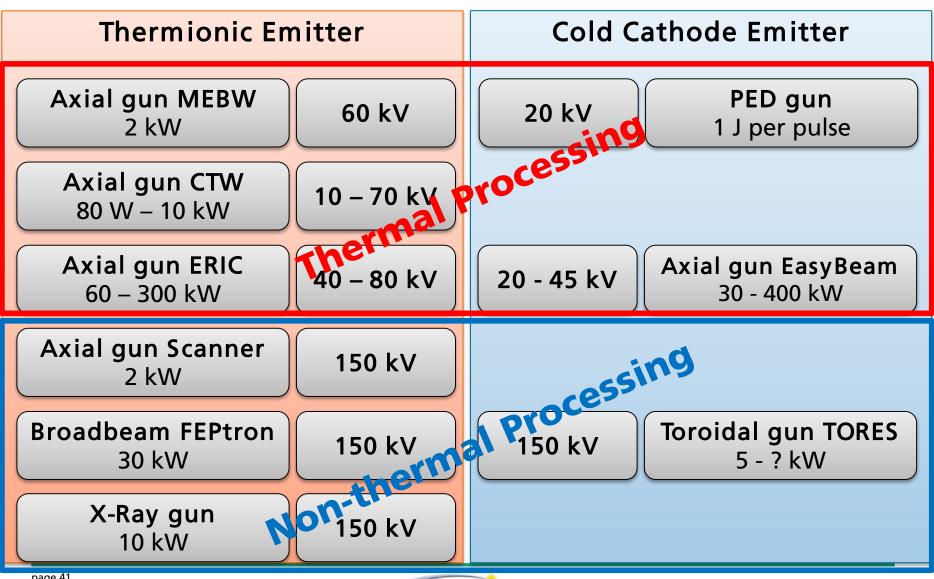


5000 fps





Customized eBeam-Sources



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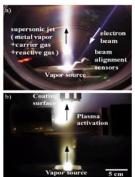




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- Customized eBeam-Sources
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Summary

- Electron beam technology is an all-round tool for application in different branches
- Processing by electron beam means:
 - energy efficiency
 - very high processing speed
 - environmental friendly
 - long term stability
 - Vacuum or non-vac processing
- We are ready to develop your special electron beam technology
 - New applications require development of customized e-beam sources
 - New e-beam sources create ideas for new applications
 - Actually there are a lot of running development projects



Electron Beam Technology

Customized Sources – Your Benefit!

Frank-Holm Rögner

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